## SHARP

Spec No.         DG-165011           Issue         15-Sep-16
ICATIONS
ENIGATA LED
V6NGNKCD06
ain <u>16</u> pages including the cover and appendix. s, please contact us before issuing purchasing order.
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s, please contact us before issuing purchasing order.          Reference         PRESENTED         BY:
Reference PRESENTED BY: Dept. General Manager
Reference PRESENTED BY: Dept. General Manager

1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please handle with great cares and do not reproduce or cause anyone to reproduce them without Sharp's consent.

2. When using this Sharp product, please observe the absolute maximum ratings, other conditions and instructions for use described in the specification sheets, as well as the precautions mentioned below.

Sharp assumes no responsibility for any damages resulting from use of the product which does not comply with absolute maximum ratings, other conditions and instructions for use included in the specification sheets, and the precautions mentioned below.

(Precautions)

- (1) In making catalogue or instruction manual based on the specification sheets, please verify the validity of the catalogue or instruction manuals after assembling Sharp products in customer's products at the responsibility of customer.
- (2) This Sharp product is designed for use in the following application areas ;
  - Computers OA equipment Telecommunication equipment (Terminal) Measuring equipment
  - Tooling machines ·Audio visual equipment · Home appliances

If the use of the Sharp product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.

- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when Sharp product is used for equipment in responsibility of customer which demands high reliability and safety in function and precision, such as ;
  - Transportation control and safety equipment (aircraft, train, automobile etc.)
  - Traffic signals Gas leakage sensor breakers Rescue and security equipment
  - · Other safety equipment

(4)Sharp product is designed for consumer goods and controlled as consumer goods in production and quality.

Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;

- Space equipment Telecommunication equipment (for trunk lines)
- Nuclear power control equipment 
   Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any question regarding interpretation of the above four paragraphs.
- 3. Disclaimer

The warranty period for Sharp product is one (1) year (or six (6) months in case of generalized product) after shipment. During the period, if there are any products problem, Sharp will repair (if applicable), replace or refund. Except the above, both parties will discuss to cope with the problems.

The failed Sharp product after the above one (1) year (or six (6) month for generalized product) period will be coped with by Sharp, provided that both parties shall discuss and determine on sharing responsibility based on the analysis results thereof subject to the above scope of warranty.

The warranty described herein is only for Sharp product itself which are purchased by or delivered to customer. Damages arising from Sharp product malfunction or failure shall be excepted.

Sharp will not be responsible for the Sharp product due to the malfunction or failures thereof which are caused by: (1) storage keep trouble during the inventory in the marketing channel.

(2) intentional act, negligence or wrong/poor handling.

(3) equipment which Sharp products are connected to or mounted in.

(4) disassembling, reforming or changing Sharp products.

(5) installation problem.

(6) act of God or other disaster (natural disaster, fire, flood, etc.)

(7) external factors (abnormal voltage, abnormal electromagnetic wave, fire, etc.)

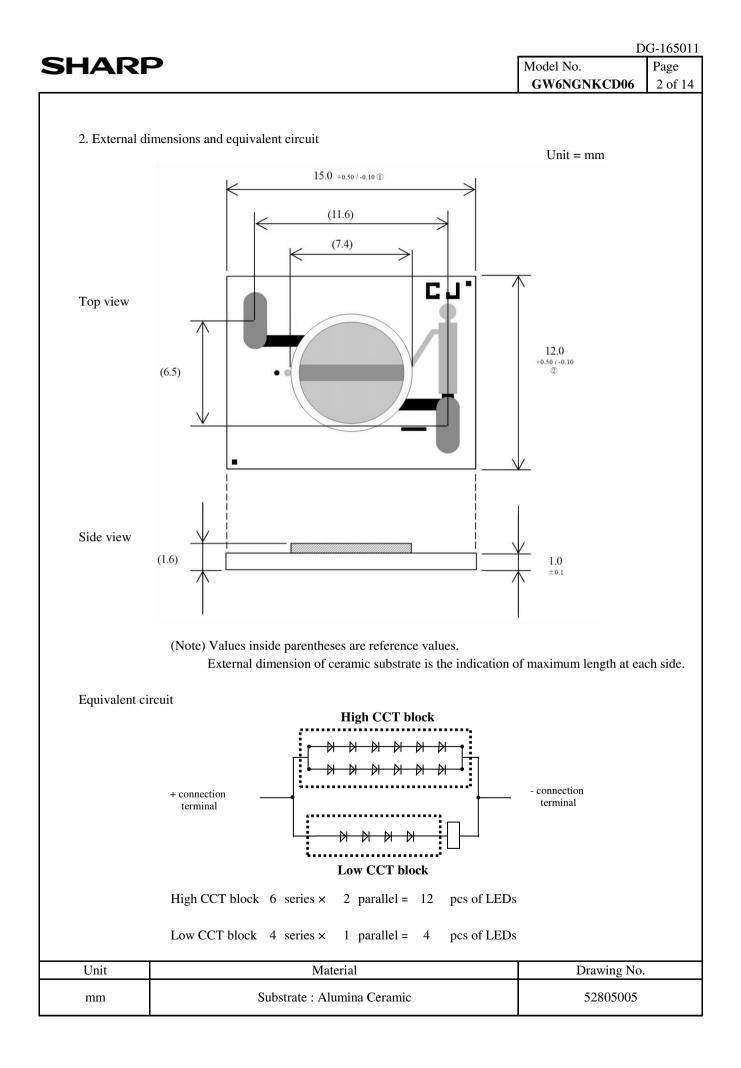
(8) special environment (factory, coastal areas, hotspring area, etc.)

(9) phenomenon which cannot be foreseen based on the practical technologies at the time of shipment.

(10) the factors not included in the product specification sheet.

4. Please contact and consult with a Sharp sales representative for any questions about Sharp product.

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HARP	Model No. GW6NGNKCD06	Page 1 of
GW6NGNKCD06 sp	ecifications	
1. Application		
These specifications apply to the light emitting diode mod [ LED module (InGaN Blue LED chip + Phosphor) ] Main application : Lighting	dule Model No. GW6NGNKCD06.	
2. External dimensions and equivalent circuit	Refer to Page 2	
3. Ratings and characteristics	Refer to Page 3 - 5.	
3-1. Absolute maximum ratings		
3-2. Electro-optical characteristics		
3-3. Derating curve		
4. Reliability	Refer to Page 6.	
4-1. Test items and test conditions		
4-2. Failure criteria		
5. Quality level	Refer to Page 7.	
5-1. Applied standard		
<ul><li>5-2. Sampling inspection</li><li>5-3. Inspection items and defect criteria</li></ul>		
5.5. Inspection tents and detect enterta		
6. Supplements	Refer to Page 8 - 10.	
6-1. Chromaticity rank table		
6-2. Packing		
6-3. Label		
6-4. Indication printed on product		
7. Precautions	Refer to Page 11 - 13.	
8. Characteristics diagram (TYP.)	Refer to Page 14.	



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3. Ratings and characteristics

#### 3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power Dissipation *1,4	Р	7.7	W
Forward Current *1,4	I <sub>F</sub>	400	mA
Reverse Voltage *2,4	V <sub>R</sub>	-15	V
Operating Temperature *3	T <sub>opr</sub>	- 30 ~ + 100	°C
Storage Temperature	T <sub>stg</sub>	- 40 ~ + 100	°C

\*1 Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

\*2 Voltage resistible at initial connection error

(Not dealing with the possibility of always-on reverse voltage.)

\*3 Case temperature Tc (Refer to measuring point for case temperature in the next page.) Refer to "Derating curve" in the next page as for operating current.

\*4 Tc= 25 °C

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## 3-2. Electro-optical characteristics

	1							$(T_j =$	25 °C)	
CCT	Item	Symbol	С	onditi	on	MIN.	TYP.	MAX.	Unit	
	Forward Voltage *5	VF				12.3	13.8	15	V	
	Luminous Flux *6	Φ				43	(48)	-	lm	
1900K	Chromaticity Coordinates *7	х	$\mathbf{I}_{\mathrm{F}} =$	50	mA	-	(0.5377)	-	-	
	Chromaticity Coordinates *7	y	У				-	(0.4130)	-	-
	General Color Rendering Index *8	Ra				90	(92)	-	-	
	Forward Voltage *5	VF				16.5	18	19.2	V	
	Luminous Flux*6	Φ				490	(545)	-	lm	
3000K	Chromaticity Coordinates *7	х	$\mathbf{I}_{\mathrm{F}} =$	350	mA	-	(0.4370)	-	-	
	containation y cooldinates · 7	У				-	(0.4030)	-	-	
	General Color Rendering Index *8	Ra				90	(94)	-	-	

(Note) Values inside parentheses are shown for reference purpose only.

- \*5 (After 5 ms drive, Measurement tolerance:  $\pm$  3 %)
- \*6 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A (After 5 ms drive, Measurement tolerance: ± 10 %)
- \*7 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A (After 5 ms drive, Measurement tolerance: ± 0.005)
- \*8 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A (After 5 ms drive, Measurement tolerance: ± 2)

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#### DG-165011 SHARP Model No. Page GW6NGNKCD06 5 of 14 3-3. Derating curve Forward Current Derating Curve 400 Forward Current I<sub>F</sub> [mA] 300 200 100 0 -20 -10 10 20 30 40 60 70 80 90 100 110 -30 0 50

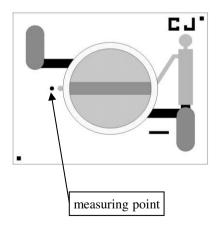
(Note) To keep the case temperature lower than the rating, enough heat-radiation performance needs to be secured by using an adequate heat sink.

Case Temperature  $T_c$  [°C]

For soldering connection, please evaluate in your circumstance to make sure soldering reliability. (Above derating curve is specified to LED device, not for soldering connection) And please consider to avoid physical stress between wire and substrate, and some protection like silicon bond on top of soldered wire is recommended.

Please ensure the maintenance of heat radiation not to exceed case temperature over the rating in operation.

(Measuring point for case temperature)



Please take note of the following, when measuring case temperature. 1 The LED device mounting surface should be flat/plain surface.

2 The substrate surface temperature should be uniform.

Thermal Resistance: 6.2 °C/W(Typical value)

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## 4. Reliability

The reliability of products shall be satisfied with items listed below.

4-1. Т	Test items and test condit	tions	Co	nfidence le	vel: 90 %
No.	Test item	Test conditions	Samples	Defective	LTPD
			n	C	(%)
1	Temperature Cycle	- 40 °C(30 min) $\sim$ + 100 °C(30 min), 100 cycles			
			11	0	20
2	Temperature Humidity	$T_{stg} = +60 ^{\circ}\text{C}, \text{RH} = 90 ^{\circ}\text{, Time} = 1000 \text{ h}$			
	Storage		11	0	20
3	High Temperature	$T_{stg} = +100^{\circ}C$ , Time = 1000 h			
	Storage		11	0	20
4	Low Temperature	$T_{stg} = -40 \text{ °C}$ , Time = 1000 h			
	Storage		11	0	20
5	Steady State Operating	$T_c = 90 \text{ °C}, I_F = 350 \text{ mA}, \text{ Time} = 1000 \text{ h}$			
	Life		11	0	20
6	Shock	Acceleration: 15000 m/s <sup>2</sup> , Pulse width: 0.5 ms			
		Direction: 3 directions (X, Y and Z)			
		3 trials in each direction	5	0	50
7	Vibration	Frequency: 100 to 2000 Hz for 4 minutes per trial			
		Acceleration: 200 m/s <sup>2</sup>			
		Direction: 3 directions (X, Y and Z)			
		4 trials in each direction	5	0	50

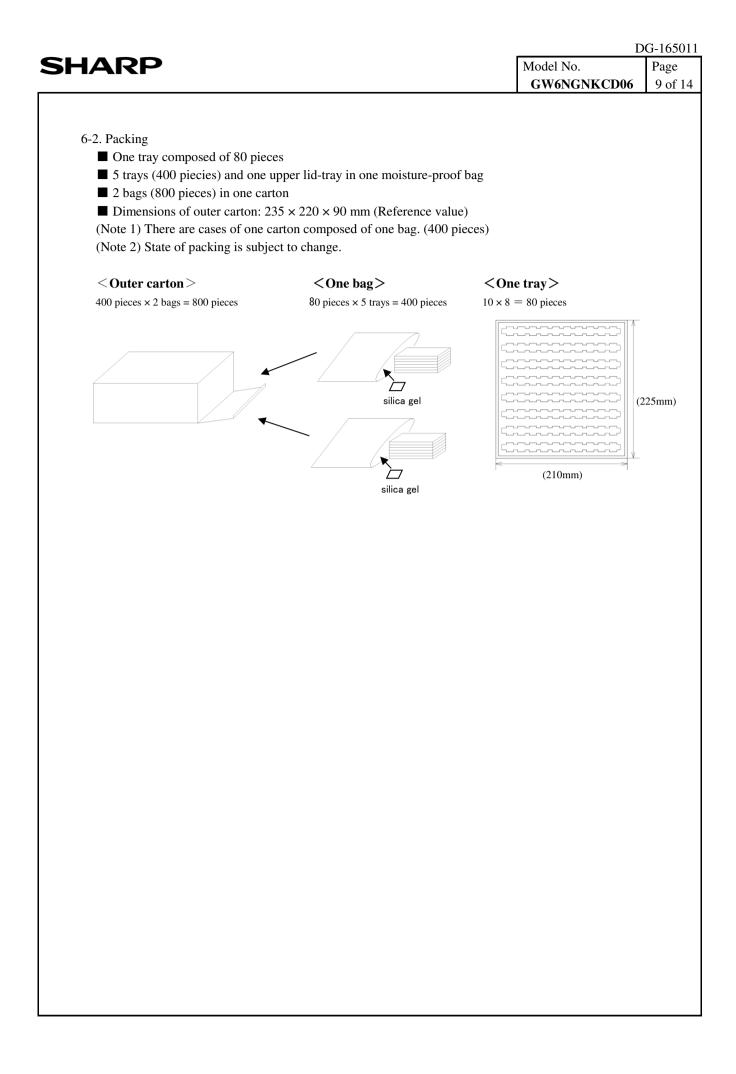
### 4-2. Failure criteria

No.	Parameter	Symbol	Failure criteria
1	Forward Voltage	V <sub>F</sub>	$V_F > Initial value \times 1.1$
2	Luminous Flux	Φ	$\Phi$ < Initial value × 0.7

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łA	<b>IRP</b>		Model No.		Page
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5. Qu	ality level				
5-1. /	Applied standard				
IS	SO2859-1				
	<b>.</b>				
	Sampling inspecti				
A	single normal sa	mpling plan, level S-4.			
531	inspection items	and defect criteria			
5-3. I No.	Inspection items a Item	nd defect criteria Defect criteria	Classification	AQI	<u> </u>
	<b>1</b> <sup>*</sup>		Classification Major	AQI	
No.	Item	Defect criteria		AQI 0.1	
No.	Item	Defect criteria	Major		
No. 1	Item No radiation	Defect criteria No light emitting	Major		
No. 1	Item No radiation Electro-optical	Defect criteria           No light emitting           Not conforming to the specification	Major		<u></u>
No. 1 2	Item No radiation Electro-optical characteristics	Defect criteria           No light emitting           Not conforming to the specification           (Forward voltage, Luminous flux and Chromaticity)	Major		<u></u>
No. 1 2	Item No radiation Electro-optical characteristics External	Defect criteria           No light emitting           Not conforming to the specification           (Forward voltage, Luminous flux and Chromaticity)           Not conforming to the specified dimensions	Major		
No. 1 2 3	Item No radiation Electro-optical characteristics External dimensions	Defect criteria         No light emitting         Not conforming to the specification         (Forward voltage, Luminous flux and Chromaticity)         Not conforming to the specified dimensions         (External dimensions of ① and ② shown in Page 2)	Major defect		
No. 1 2 3	Item No radiation Electro-optical characteristics External dimensions	Defect criteria           No light emitting           Not conforming to the specification           (Forward voltage, Luminous flux and Chromaticity)           Not conforming to the specified dimensions           (External dimensions of ① and ② shown in Page 2)           Nonconformity observed in product appearance is determined	Major defect Minor	0.1	
No. 1 2 3	Item No radiation Electro-optical characteristics External dimensions	Defect criteria           No light emitting           Not conforming to the specification           (Forward voltage, Luminous flux and Chromaticity)           Not conforming to the specified dimensions           (External dimensions of ① and ② shown in Page 2)           Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by.	Major defect Minor	0.1	
No. 1 2 3	Item No radiation Electro-optical characteristics External dimensions	Defect criteria         No light emitting         Not conforming to the specification         (Forward voltage, Luminous flux and Chromaticity)         Not conforming to the specified dimensions         (External dimensions of ① and ② shown in Page 2)         Nonconformity observed in product appearance is determined         as defective only when electro-optical characteristics is affected by. <if above="" any="" arises="" criterion="" mentioned="" of="" question="" regardless=""></if>	Major defect Minor defect	0.1	
No. 1 2 3	Item No radiation Electro-optical characteristics External dimensions	Defect criteria         No light emitting         Not conforming to the specification         (Forward voltage, Luminous flux and Chromaticity)         Not conforming to the specified dimensions         (External dimensions of ① and ② shown in Page 2)         Nonconformity observed in product appearance is determined         as defective only when electro-optical characteristics is affected by. <if above="" any="" arises="" criterion="" mentioned="" of="" question="" regardless="">         ■ Foreign material, scratch, or bubble at emitting area: 0.8 mm φ</if>	Major defect Minor defect	0.1	

(Note) Products with removable foreign material attached on is not determined to be defective.

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6. Supple	ements							
6-1. Chr	omaticity ran	k table				(Tolerance	: x,y $\pm 0.005$ ) (T <sub>j</sub> = 25 °C)	
ランク			Chromatic	ity Diagra	m			
]~)		Point		Point 3	Point 4			
	1900K	x 0.523		0.5523	0.5309			
1	(I <sub>f</sub> =50mA)	y 0.408		0.4180	0.4180			
	3000K (I <sub>f</sub> =350mA)	x 0.428' y 0.398		0.4454 0.4080	0.4334 0.4080			
			Cl	hromaticity 1	Diagram			
0.440								
0.420		5-5-1	7					1
> 0.400 0.380	3200k		,					
		3000K 2800K			2000	K 1800K		
		,			/	1		



ARP		Model No.
		GW6NGNKCD06
3. Label		
1)Outer carton		
Following label is attached		
(Note 3) Label format is subjected	d to change.	1) Lot No. indication
	Г	XX 11 B 25
SHIPMENT TABLE	22	
PART No. GW6NGNKCD06	←Model number ←(Model number+suffix code)	① Production plant code
(GW6NGNKCD06M) QUANTITY: 800	←Quantity	② Shipping year (Year last 2 digits)
LOT No. XX11B25	←Lot No. ←Rank	③ Shipping month
RANK 1 SHARP CORPORATION	Nank	(from January to December in ABC
MADE IN XXXXXXXXXX	← Production country • MADE IN INDONESIA	(4) Shipping date $(01 \sim 31)$
	in the introduction	*Notation may be different
SWAP LAGEL		
2)Moisture-Proof bag Following label is attached (Note 3) Label format is subjected SHIPMENT TABLE PART No. GW6NGNKCD06 (GW6NGNKCD06M) QUANTITY : 400 RANK 1 LOT No. 5020G2064A SHARP CORPORATION MADE IN XXXXXXXXXXX R.C.	d to change. ← Model number ← (Model number+suffix code) ← Quantity and rank ← Lot No.	<ol> <li>Lot No. indication</li> <li>XX 1 9 G 11 123 A         <ol> <li>(1) (2) (3) (4) (5) (6) (7)</li> <li>(1) Production plant code</li> <li>(2) Shipping year (Year last digit)</li> <li>(3) Shipping month (1~9 or O, N, D)</li> <li>(4) Fixed code G</li> <li>(5) Shipping date (01~31)</li> </ol> </li> </ol>
2)Moisture-Proof bag Following label is attached (Note 3) Label format is subjected SHIPMENT TABLE PART No. GW6NGNKCDO6 (G	d to change. ←Model_number ←(M odel_number+suffix code) ←Quantity and rank	<ol> <li>Lot No. indication</li> <li>XX 1 9 G 11 123 A         <ol> <li>(1) (2) (3) (4) (5) (6) (7)</li> <li>(1) Production plant code</li> <li>(2) Shipping year (Year last digit)</li> <li>(3) Shipping month (1~9 or O, N, D)</li> <li>(4) Fixed code G</li> <li>(5) Shipping date (01~31)</li> <li>(6) Serial No.</li> </ol> </li> </ol>
2)Moisture-Proof bag Following label is attached (Note 3) Label format is subjected SHIPMENT TABLE PART No. GW6NGNKCD06 (GW6NGNKCD06M) QUANTITY : 400 RANK 1 LOT No. 5020G2064A SHARP CORPORATION	d to change. ← Model number ← (Model number+suffix code) ← Quantity and rank ← Lot No. ← Production country	<ol> <li>Lot No. indication</li> <li>XX 1 9 G 11 123 A         <ol> <li>(1) (2) (3) (4) (5) (6) (7)</li> <li>(1) Production plant code</li> <li>(2) Shipping year (Year last digit)</li> <li>(3) Shipping month (1~9 or O, N, D)</li> <li>(4) Fixed code G</li> <li>(5) Shipping date (01~31)</li> </ol> </li> </ol>

6-4. Indication printed on product

Model No. and control No. are indicated on substrate surface.

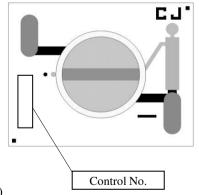
1) Control No.

Indicated as follows; GNKC6 1 4 F 11 ① ② ③ ④ ⑤

- 1 Abbreviated Model No.
- 2 Chromaticity Rank
- (3) Year of production (Year end 2014 $\Rightarrow$ "4")
- ④ Month of production

(to be indicated alphabetically with January corresponding to A)

(5) Date of production (01 $\sim$ 31)



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7. Precautions		
① Storage conditions		
Please follow the conditions below.		
• Before opened: Temperature 5 $\sim$ 30 °C, Relative humidity less than 60	)%.	
(Before opened LED should be used within a year)		
• After opened: Temperature 5 $\sim$ 30 °C, Relative humidity less than 60 °C	%.	
(Please apply soldering within 1 week)		
•After opened LED should be kept in an aluminum moisture proof bag wi	th a moisture	
absorbent material (silica gel).		
• Avoid exposing to air with corrosive gas.		
If exposed, electrode surface would be damaged, which may affect solde	ring.	
② Usage conditions		
This product is not designed for the use under any of the following condi-		
Please carefully check the performance and reliability well enough in cas	e of using under any of the	
following conditions;		
• In a place with a lot of moisture, dew condensation, briny air, and corros (Cl, H2S, NH3, SO2, NOX, etc.)	ive gas.	
•Under the direct sunlight, outdoor exposure, and in a dusty place.		
•In water, oil, medical fluid, and organic solvent.		
Please do not use component parts like rubber which may contain sulfur (a	gasket packing, adhesive ma	terial,
etc.).		
Please note that any strong acidic or alcoholic elements could effect the si		
The heat and light released from the LED device, could generate halogen		
which may have adverse impact on the module. Before using please consi	der carefully about this issue	2.
③ Heat radiation and Installation		_
If forward current (IF) is applied to single-state module at any current, the or emitting smoke, due to increase in temperature.	ere is a risk of damaging LE	D
Equip with specified heat radiator(heat sink), and avoid heat being stuffed	inside the module.	
Material of substrate is alumina ceramic. If installed inappropriately, troul	ole of insufficient heat radiat	tion may
occur, which may result in board cracks or lighting defects due to overhe	at. Please take particular no	tice for
installation.		
Refer to the following cautions while installing the LED device on heat sin	nk.	
• Apply thermolysis adhesive, adhesive sheet or peculiar connector when a	mounted on heat radiator.	
In case of applying adhesive or adhesive sheet only, check the effectiven		-
If LED comes off from heat radiator, unusual temperature rise entails has	-	-
device deterioration, coming off of solder at leads, and emitting smoke, a		
•When LED device is mechanically fixed or locked, Please take into cons	ideration regarding the meth	od of
attachment due to fail from stress.		
• Please apply appropriate stress and design carefully, when fixing the LE	D device using holder. Any	
excessive or uneven stress could break LED device's substrate.		
• Avoid convexly uneven boards.		

Convex board is subject to substrate cracking or debasement of heat release.

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• It is recommended to apply adhesive or adhesive sheet with high therm	al conductivity	
for radiation of heat effectively.		
•Please take care about the influence of color change of adhesive or adhe	esive sheet in initial and long	term
period, which may affect light output or color due to change of reflectation	nce from backside.	
•Any excessive or uneven stress on the ceramic substrate could break the	e substrate. Please design such	n that,
proper/uniform stress is applied on the substrate, when fixing the LED	device using a holder.	
•When fixing the LED device with a holder, please take note if any exce	essive or uneven stress is appli	ed
when pressing the substrate with holder. Due to this, the gap may arise	between LED device and	
adhesive material, which may affect the heat dissipation of the device.		
•Do not touch resin part including white resin part on the surface of LEI	).	
No light emission may occur due to damage of resin or cutting wire of	LEDs by outer force.	
When using tweezers, please handle by ceramic substrate part and avoid	touching resin part.	
For mounting, please handle by side part of ceramic or the specified area	a shown below.	
The current control circuit on the substrate has current controlling function	on.	
Therefore, do not touch or damage this area when handling the LED at the	he time of mounting or after m	ounting.
Handling a	rea	
•The outer edges of the substrate may be uneven in some cases. Please a points, while designing for installation.	avoid choosing these areas as	fixing
• In case of using heat radiation sheet or heat radiation adhesive, light re	flection or absorption of these	
materials may influence the output of LED device. Especially, the colo	•	
long-term use has direct impact on output of LED devices, and hence c	-	ed
while choosing the radiation sheet ro adhesive.	1	
•The current control circuit on the substrate gets hot when the device is	in use. Please confirm perform	nance
and reliability of the materials that are used near this area, when choose		
① Connecting method		
Use soldering for conncetions. Follow the conditions mentioned below, t	to preserve the connection stre	ngth.
•Use soldering iron with thermo controller (tip temperature 380 °C), wi	thin 5 seconds per one place.	C
• Secure the solderwettability on whole solder pad and leads.		
• During the soldering process, put the ceramic board on materials who	se conductivity is poor enough	ı
not to radiate heat of soldering.		
•Warm up (with using a heated plate) the substrate is recommended bef	ore soldering.	
( preheat condition: 100 $^\circ \mathrm{C} \sim$ 150 $^\circ \mathrm{C}$ , within 60 sec )		
• Avoid touching any part of resin with soldering iron.		

- Avoid touching any part of resin with soldering iron.This product is not designed for reflow and flow soldering.
- Please do not use solder paste for soldering pad.
- Avoid such lead arrangement as applying stress to solder-applied area.
- Please do not detach solder and make re-solder.
- •Please solder evenly on each electrode.
- ${\boldsymbol \cdot}$  Please prevent flux from touching to resin.
- •Do the soldering on stable stand. Avoid soldering on moving or vibrating objects.
- •Please avoid touching the soldering unit to resin.

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5 Static electricity		• . • • • • • •		
	tatic electricity, so take measures like wearing wi	rist band to cope with it.		
Install circuit protection de	vice to drive circuit, if necessary.			
6 Drive method				
• Any reverse voltage can	not be applied to LEDs when they are in operation	n or not.		
Design a circuit so that an	y flow of reverse or forward voltage can not be a	pplied to LEDs		
when they are out of operation	ation.			
•Module is composed of L	EDs connected in both series and parallel.			
Constant voltage power su	upply runs off more than specified current amount	t due to lowered VF		
caused by temperature rise	e. Constant current power supply is recommended	l to drive.		
<ul> <li>Be cautious while putting</li> </ul>	on/off the power supply, as excess current, excess	ss voltage or reverse volta	ge may §	
injucted to the device in s	ome cases.			
⑦ Cleaning				
e	device may be effected in some cases by cleanin	ıg.		
		C		
⑧ Color-tone variation				
Chromaticity of this produ-	ct is monitored by integrating sphere right after th	ne operation.		
Chromaticity varies dependent	ding on measuring method, light spread condition	, or ambient temperature.		
Please verify your actual c	onditions before use.			
③ Safety				
•	for a long time may result in hurting your eyes.			
	(over ratings) is supplied to the device, hazardou	is phenomena including		
	emitting smoke, or catching fire can be caused.	is phonomena moraanig		
_	s to excess current and voltage.			
	ng method, there is a possibility of fatigue failure	by heat.		
	h case to protect from short circuit or leakage of	-	ict.	
	standards or regulations of application devices.	5		
-	strate edges, that may injure your hands.			
① Other cautions	bliance to the quality standards mentioned in the s	manifications		
-	the compatibility with application of the end-use,	-		
and usage environment.	the compatibility with application of the end-use,	including assembly		
-	ns occurred in the application of end-use, details	will be separately discusse	bd	
and determined between th	**	will be separately discusse	Ju	
	e partes nereto.			

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#### 8. Characteristics diagram (TYP.)

